Attorney Docket No.: 107317-00061

**AMENDMENTS TO THE CLAIMS:** 

This listing of claims will replace all prior versions and listings of the claims in

the above-captioned patent application.

**Listing of Claims:** 

1. (Currently Amended) A solid state image pickup device comprising:

a semiconductor substrate having a first layer of a first conductivity type;

a second layer of a second conductivity type opposite to the first conductivity

type, said second conductivity type layer being formed on the first conductivity type

layer of said semiconductor substrate;

a first region of the first conductivity type formed in said second conductivity type

layer and constituting a photodiode with said second conductivity type layer;

a first gate structure including a charge storage region and a control gate, said

first gate structure being formed on a surface of said semiconductor substrate adjacent

to a portion of said first region, and said charge storage region being electrically isolated

from said first region;

a second region of the first conductivity type formed adjacent to said first gate

structure on a side opposite to said first region, and constituting a non-volatile memory

element with said first region and said first gate structure;

an optical window formed on said first region and made of transparent material;

and

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a control circuit for applying a first write voltage to the control gate of said first

gate structure, the first write voltage being a write voltage for tunneling and injecting

charges accumulated in said first region into the charge storage region.

2. (Original) The solid state image pickup device according to claim 1, wherein

said control circuit applies a second write voltage to the control gate of said first gate

structure and to the second region after the first write voltage is applied, the second

write voltage being a write voltage for injecting charges accumulated in said first region

into the charge storage region as hot carrier injection.

3. (Original) The solid state image pickup device according to claim 1, further

comprising:

a second gate structure of an insulated gate type formed adjacent to another

portion of said first region; and

a third region of the first conductivity type formed adjacent to a side of said

second gate structure opposite to said first region, said third region constituting an

insulated gate type transistor with said first region and said second gate structure.

4. (Currently Amended) The solid state image pickup device according to claim

1, further comprising a third region of the first conductivity type projecting from an upper

surface of the first conductivity type layer of said semiconductor substrate said first layer

into said second conductivity type layer.

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5. (Original) The solid state image pickup device according to claim 1, wherein

the charge storage region of the non-volatile memory element has a floating gate.

6. (Original) The solid state image pickup device according to claim 1, wherein

the charge storage region of the non-volatile memory element has an interface between

a silicon nitride film and a silicon oxide film.

7. (Currently Amended) A solid state image pickup device comprising:

a semiconductor substrate having a first layer of a first conductivity type;

a second layer of a second conductivity type opposite to the first conductivity

type, said second conductivity type layer being formed on the first conductivity type

layer of said semiconductor substrate;

a first region of the first conductivity type formed in said second conductivity type

layer and constituting a photodiode with said second conductivity type layer;

a first gate structure including a charge storage region and a control gate, said

first gate structure being formed on a surface of said semiconductor substrate adjacent

to a portion of said first region, and said charge storage region being electrically isolated

from said first region;

a second region of the first conductivity type constituting a non-volatile memory

element with said first region and said first gate structure, formed adjacent to said first

gate structure on a side opposite to said first region;

an optical window formed on said first region and made of transparent material;

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a second gate structure of an insulated gate type formed adjacent to another

portion of said first region; and

a third region of the first conductivity type formed adjacent to said second gate

structure on a side opposite to said first region, said third region constituting an

insulated gate type transistor with said first region and said second gate structure.

8. (Original) The solid state image pickup device according to claim 7, further

comprising a control circuit for applying a bias voltage to said second gate structure to

turn on the insulated gate type transistor and supplying current to the non-volatile

memory element.

9. (Original) The solid state image pickup device according to claim 7, wherein

the charge storage region of the non-volatile memory element has a floating gate.

10. (Original) The solid state image pickup device according to claim 7, wherein

the charge storage region of the non-volatile memory element has an interface between

a silicon nitride film and a silicon oxide film.

11. (Currently Amended) A solid state image pickup device comprising:

a semiconductor substrate having a first layer of a first conductivity type;

a <u>second</u> layer of a second conductivity type opposite to the first conductivity

type, said second conductivity type layer being formed on the first conductivity type

layer of said semiconductor substrate;

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a first region of the first conductivity type formed in said second conductivity type

layer and constituting a photodiode with said second conductivity type layer;

a first gate structure including a charge storage region and a control gate, said

first gate structure being formed on a surface of said semiconductor substrate adjacent

to a portion of said first region, and said charge storage region being electrically isolated

from said first region;

a second region of the first conductivity type formed adjacent to said first gate

structure on a side opposite to said first region, and constituting a non-volatile memory

element with said first region and said first gate structure;

an optical window formed on said first region and made of transparent material;

and

a control circuit for applying a forward bias voltage to the first conductive type

layer of said semiconductor substrate to supply current to the non-volatile memory

element.

12. (Currently Amended) The solid state image pickup device according to claim

11, further comprising a third region of the first conductivity type projecting from an

upper surface of the first conductivity type layer of said semiconductor substrate said

first layer into said second conductivity type layer.

13. (Original) The solid state image pickup device according to claim 11,

wherein the charge storage region of the non-volatile memory element has a floating

gate.

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14. (Original) The solid state image pickup device according to claim 11, wherein

the charge storage region of the non-volatile memory element has an interface between

a silicon nitride film and a silicon oxide film.

15. (Currently Amended) A driving method for a solid state image pickup device,

comprising the steps of:

(a) applying light to photodiodes distributed in a matrix layout and accumulating

charges representative of image information, said photodiodes being formed in a

second conductivity type layer formed on a first conductivity type layer of a

semiconductor substrate, the first conductivity type being opposite to the second

conductivity type second layer having a second conductivity type and being formed on a

first layer of a semiconductor substrate, said first layer having a first conductivity type

opposite to said second conductivity type, said solid state image pickup device having

optical windows made of transparent material and formed respectively on said

photodiodes;

(b) applying a first write control voltage to a control gate of a non-volatile memory

element having a charge storage region, the control gate and a drain region, the non-

volatile memory element being formed adjacent to each of the photodiodes, each of

said charge storage regions being electrically isolated from associated one of said

photodiodes, and tunneling and injecting at least a portion of the charges representative

of the image information into the charge storage region as signal charges; and

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(c) applying a read control voltage to the non-volatile memory element to detect a

threshold voltage corresponding to an amount of the signal charges injected at said step

(b) into the charge storage region.

16. (Original) The driving method for a solid state image pickup device according

to claim 15, further comprising a step of, before said step (c):

(d) applying a second write control voltage to the control gate and drain region of

the non-volatile memory element and injecting as hot carriers at least a portion of the

charges representative of the image information into the charge storage region as signal

charges.

17. (Original) The driving method for a solid state image pickup device

according to claim 15, wherein said step (c) includes a sub-step of:

(e) applying a bias voltage to an insulated gate type transistor formed adjacent to

another portion of each of the photodiodes to turn on the transistor and supply a

channel current to the non-volatile memory element.

18. (Currently Amended) The driving method for a solid state image pickup

device according to claim 15, wherein said step (c) includes a sub-step of:

(f) applying a forward bias voltage to the first conductivity type layer of the

semiconductor substrate to supply a channel current to the non-volatile memory

element.

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19. (Currently Amended) The driving method for a solid state image pickup device according to claim 15, wherein said step (c) includes a sub-step of:

(g) applying a forward bias voltage to a first region of the first conductivity type

formed projecting from an upper surface of the first conductivity type layer of the

semiconductor substrate into the second conductivity type layer to supply a channel

current to the non-volatile memory element.

20. (Original) The driving method for a solid state image pickup device according

to claim 15, further comprising a step of, before said step (a):

(h) applying a reverse bias voltage to the first conductivity type layer of the

semiconductor substrate to drain charges accumulated beforehand in the photodiodes

to a semiconductor substrate side.